



ZLLS350

40V LOW LEAKAGE SCHOTTKY DIODE

**Features**

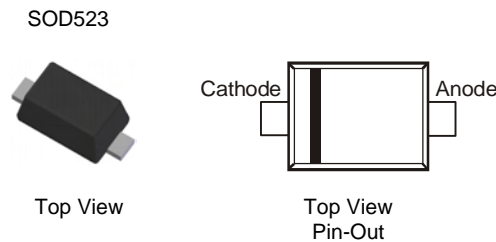
- Low  $V_F$
- 380mA continuous current rating
- Low profile SOD523 package
- **Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

**Description**

Packaged in the SOD523 package offering an ideal low  $V_F/I_R$  performance combined with a low package height making the device suitable for various converter, charger and LED driver circuits

**Mechanical Data**

- Case: SOD523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish - Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (approximate)

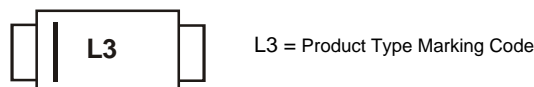


**Ordering Information** (Note 4)

Part Number	Case	Packaging
ZLLS350TA	SOD523	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
  3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

**Marking Information**



### Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
DC Blocking Voltage	$V_{RM}$	40	V
Continuous Forward current	$I_F$	380	mA
Average Peak Forward Current; duty cycle = 50%	$I_{FAV}$	650	mA
Non-Repetitive Forward Current		@ $t < 100\mu\text{s}$	6.0
		@ $t < 10\text{ms}$	1.3
Power Dissipation at $T_A = 25^\circ\text{C}$ (Note 5)	$P_D$	357	mW
Power Dissipation at $T_A = 25^\circ\text{C}$ (Note 6)	$P_D$	413	mW
Operating and storage temperature range	$T_{STG}$	-55 to +150	$^\circ\text{C}$
Junction Temperature	$T_J$	150	$^\circ\text{C}$

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	350	$^\circ\text{C}/\text{W}$
Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	303	

### Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage	$V_{(BR)R}$	40	53	-	V	$I_R = 100\mu\text{A}$
Forward Voltage Drop (Note 7)	$V_F$	-	395	450	V	$I_F = 30\text{mA}$
		-	430	520		$I_F = 50\text{mA}$
		-	490	635		$I_F = 100\text{mA}$
		-	650	1000		$I_F = 275\text{mA}$
Leakage Current	$I_R$	-	0.15	4	$\mu\text{A}$	$V_R = 30\text{V}$
Total Capacitance	$C_T$		2.5	6		$f = 1\text{MHz}; V_R = 30\text{V}$
Reverse Recovery Time	$t_{rr}$		1		nS	Switch from $I_F = 100\text{mA}$ to $I_R = 100\text{mA}$ . Measured at $I_R = 10\text{mA}$

- Notes:
5. For a single device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of 1oz copper in still air conditions
  6. As above measured at  $t < 5$  seconds
  7. Measured under pulsed conditions. Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$

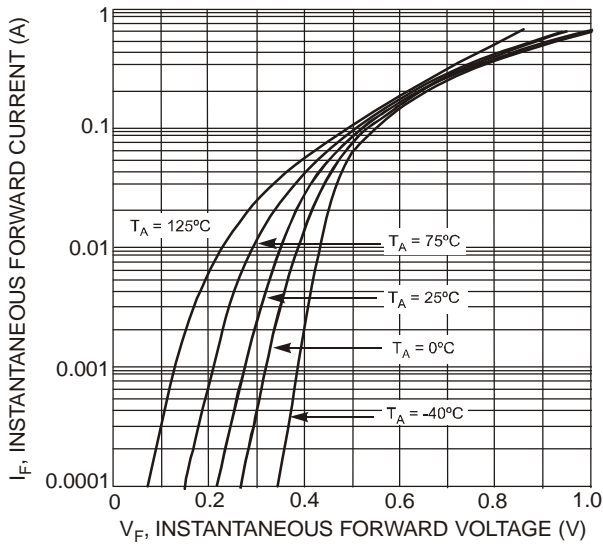


Fig. 1 Forward Characteristics

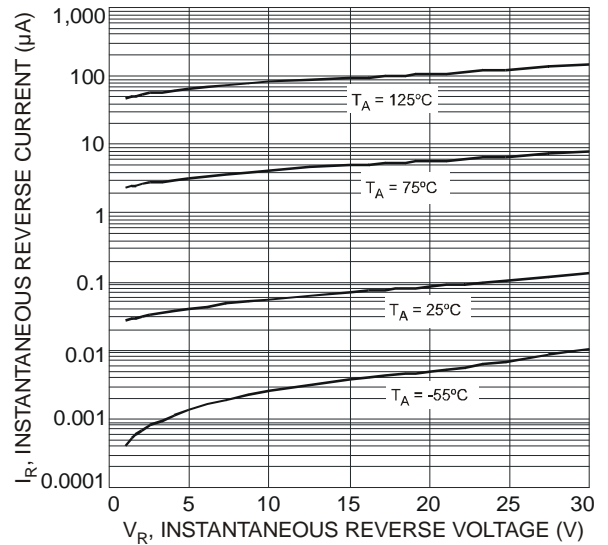


Fig. 2 Typical Reverse Characteristics

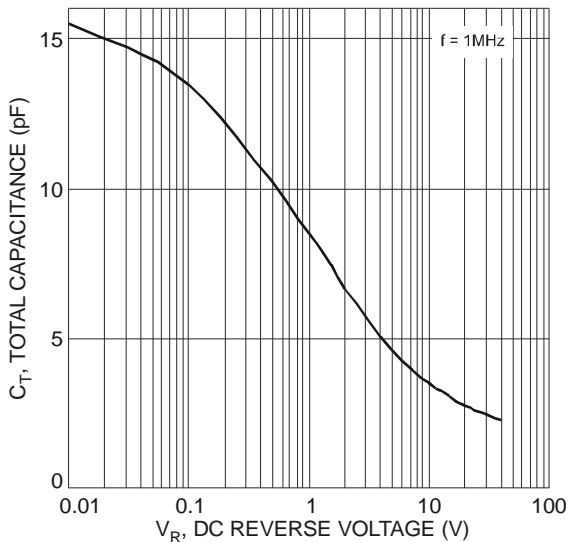


Fig. 3 Total Capacitance vs. Reverse Voltage

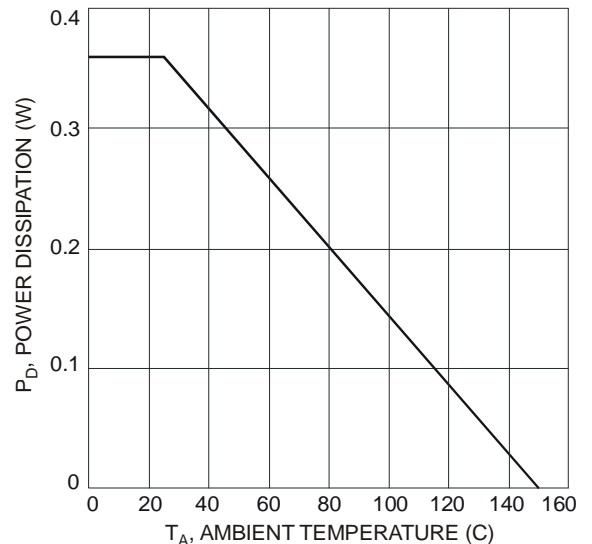
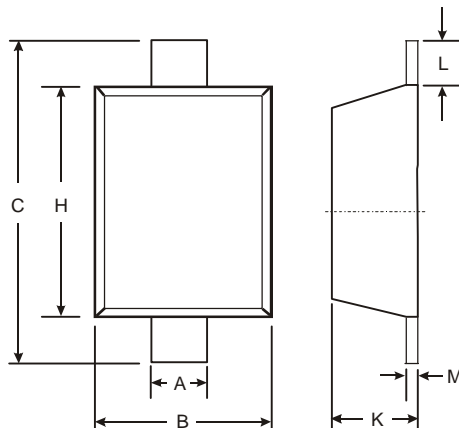


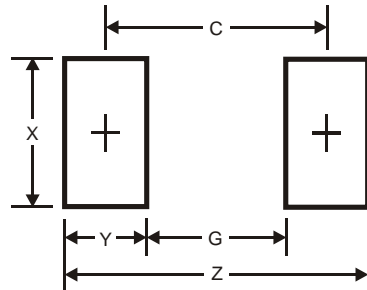
Fig. 4 Power Dissipation vs. Ambient Temperature

## Package Outline Dimensions



SOD523		
Dim	Min	Max
A	0.25	0.35
B	0.70	0.90
C	1.50	1.70
H	1.10	1.30
K	0.55	0.65
L	0.10	0.30
M	0.10	0.12
All Dimensions in mm		

## Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.3
G	1.1
X	0.8
Y	0.6
C	1.7

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